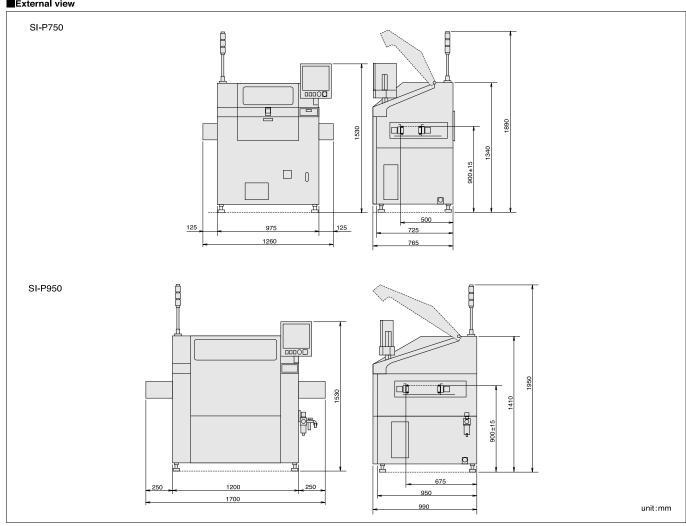
Main specifications

minim specifications		
Model name	SI-P750	SI-P950
PWB size	50mm x 50mm ~ 330mm x 250mm PWB tickness; 0.3mm ~ 2.5mm	50mm x 50mm ~ 460mm x 360mm PWB tickness; 0.3mm ~ 2.5mm
Conveyer height	900±15mm	
Printing repeatability	±10μm	
Cycle time	9sec+printing time	
Flow of work	right or left (to be specified at factory set-up)	
Screen size	650mm x 550mm x 30mm	735mm x 735mm x 30mm
Board position reference	Front side rail origin(Back side rail orgin optionally available)	
OS	Operating system ; Windows Operator interface ; Touch panel, keyboard	
Screen Cleaning	Full automatic paper cleaning (wet, dry, vacuum), manual cleaning	
Power supply/consumption	AC100V 50/60Hz 1.5 kVA(other power rating optionally available)	AC200V 50/60Hz 1.5kVA(other power rating optionally available)
Air supply/consumption	0.5MPa 63L/min(A.N.R)	
Dimensions	975(W)mm x 765(D)mm x 1,530(H)mm (Machine status light 1,890mm)	1,200(W)mm x 990(D)mm x 1,530(H)mm (Machine status light 1,950m)
Mass	760kg	1,170kg

^{*1} Only for main body

External view



A Safety Notice: For your safety, please read the instruction manual carefully before using the product. iications and appearance are subject to change without prior notice. •Windows° is a trademark of Microsoft Corp

Sony Manufacturing Systems Corporation

Sony Manufacturing Systems Corporation Surface Mounter Sales Dept. 1-10 Kiyoku-cho, Kuki-shi, Saitama-ken, 346-0035 Japa Tel:+81-480-23-4896 Fax:+81-480-23-4310

http://www.sonysms.co.py

Sony Taiwan Limited

FA Marketing Group

6F, 145 Changchun Road Taipei 104, Taiwan

Tel: +886-22522-9760 Fax: +886-2-2522-2396

http://www.sony.com.tw/company/family/FA/FA.asp

http://www.sonysms.co.jp/

The contents of this literature are as of Dec 2007

Sony Thai Co., Ltd. 2126 Kromadit Bidg., 4th FL., New Petchburi Rd., Bangkapi, Huay Kwan, Bangkok 10310, Thailand Tel: +66(0)2715-6360 Fax: +66(0)2715-6369 Tel: +0-0()/2/15-0-300 F8X: +0-0()/2/15-0-309

Sony Manufacturing Systems America, Inc.

20381 Hermana Circle, Lake Forest, CA 92630

Tel: +1-949-770-8400 Fax: +1-949-770-8408 http://www.sonysms.com Tel: +1-949-770-8400 Fax: +1-949-770-8408 http://www.sonysms.com

Sony Manufacturing Systems Europe

Headquarters

Semiconductor & Electronic Solutions A division of Sony United Kingdom Ltd.

The Heights, Brooklands, Weybridge, Surrey KT13 0XW, UK

Tel: +44-870-7390122 Fax: +44-1932-817024

Stuttgart Office

Hedellinger Strasse 61, D-70327 Stuttgart, Germany

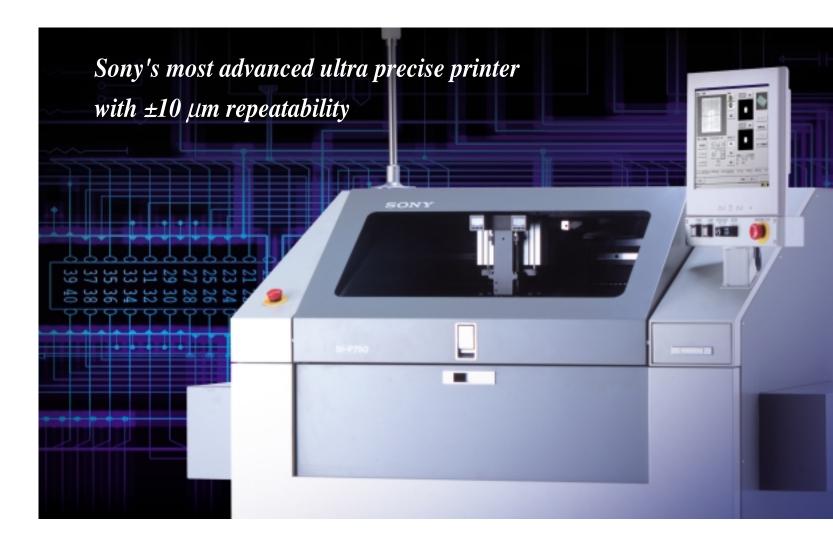
Tel: +49-711-5859-777 Fax: +49-711-58 07 15

http://www.sonymanufacturing.com

Used material: 100% recycled paper, recyclable Zero-VOC (Volatile Organic Compound) vegetable oil ink

SONY

Solder Paste Printer SI-P750 SI-P950



Solder Paste Printer



^{*} The above specifications may wary slightly depending operating conditions

^{*} Please refer to the 'Specifications' for detail

^{*} Windows logo is registered trade marks of Microsoft Corporation in the U.S and other countries

An ultracompact Sony machine that enables ultraprecision printing. Top performance through simple operation and freedom from maintenance!

A unique lineup of two models - the SI-P750 and SI-P950 embody Sony's technological advances from its own plants. High-definition printing delivering greater accuracy. Each ultraprecision unit positioned optimally for a high-performance, high-durability structure.



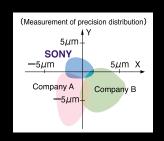
■ Ultra precision printing leading to the next generation

Printing repeatability $\pm 10\mu$ m

- Unique cast frame with high rigidity The structure features a high-rigidity cast needed to ensure printing precision.
- A printing table featuring six-spindle control for high precision and performance



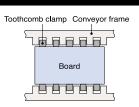
Excellent repeatability Right table shows the repeatability



Perfect plate removal

A squeegee and conveyor frame hold the metallic mask to minimize vibration. An external clamp (featuring a new toothcomb mechanism) holds the board in place. This and a vacuum system eliminate board gaps.





Sealed structure above◆ Auto cleaning

Tight sealing minimizes cream solder degradation. (Can handle lead-free solder operations)



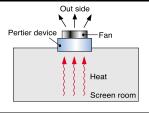
The system features special wiping paper and suction. You can program wet, dry, and vacuum.



Cooling unit

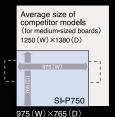
Cooling unit with Pertier device to minimize air flow to keep the quality of the solder. (Optional)

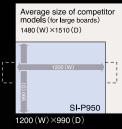




Easy installation in tight spaces

Featuring the world's most compact installation space in its class, with an ideal layout and incorporating precision assembly technology.





■ User friendly operation

- Easy, highly-efficient changeover operations Changeover can be done within 2 minutes. (A new program can be generated within 10 minutes.)
- Windows-based interactive touch panel is easy to use
- Operating wizard even for new models shortens changeovers
- Multilingual operating screen You can choose from Japanese, English, or Chinese (simplified / traditional) for changeovers.



■ High reliability and easy mainteance

 Allows continuous, maintenance-free operations Simple construction and lubrication-free operations make maintenance even easier.

